



## Material Content Data Sheet



<b>Sales Product Name</b>		IPL60R650P6S		<b>Issued</b>		19. July 2018		
<b>MA#</b>		MA001230228						
<b>Package</b>		PG-TSON-8-2		<b>Weight*</b>		92.64 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.063	3.31	3.31	33060	33060
leadframe	inorganic material	phosphorus	7723-14-0	0.010	0.01		110	
	non noble metal	zinc	7440-66-6	0.041	0.04		442	
	non noble metal	iron	7439-89-6	0.818	0.88		8830	
wire	non noble metal	copper	7440-50-8	33.217	35.85	36.78	358543	367925
	non noble metal	copper	7440-50-8	0.429	0.46	0.46	4627	4627
	encapsulation	organic material	carbon black	1333-86-4	0.102	0.11		1099
	plastics	epoxy resin	-	5.245	5.66		56619	
	inorganic material	silicondioxide	60676-86-0	45.579	49.20	54.97	491983	549701
leadfinish	non noble metal	tin	7440-31-5	1.053	1.14	1.14	11368	11368
plating	noble metal	silver	7440-22-4	0.209	0.23	0.23	2252	2252
solder	noble metal	silver	7440-22-4	0.072	0.08		777	
	non noble metal	tin	7440-31-5	0.058	0.06		621	
	non noble metal	lead	7439-92-1	2.749	2.97	3.11	29669	31067
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com